

C0805C519C3GACTU

Aliases (C0805C519C3GAC7800) SMD Comm COG, Ceramic, 5.1 pF, +/-0.25 pF, 25 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm



Click here for the 3D model.

General Information		
Series	SMD Comm COG	
Style	SMD Chip	
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I	
Features	Ultra-Stable, Low Loss, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	11 mg	
Shelf Life	78 Weeks	
MSL	1	

0% Loss/Decade Hour

100 GOhms

	Specifications	
;	Capacitance	5.1pF
+/-0.2mm	Measurement Condition	1 MHz 1.0Vrms
1m +/-0.2mm	Tolerance	+/-0.25 pF
nm +/-0.10mm	Voltage DC	25 VDC
m MIN	Dielectric Withstanding Voltage	62.5 VDC
m +/-0.25mm	Temperature Range	-55/+125°C
180mm, Paper Tape)	Temp. Coefficient	COG
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms

Aging Rate

Insulation Resistance

0805 Chip Size L 2mm W 1.25mr Т 0.78m s 0.7mn В 0.5mn

Packaging Specifications Packaging

Packaging Quantity

Dimensions

T&R, 18 4000

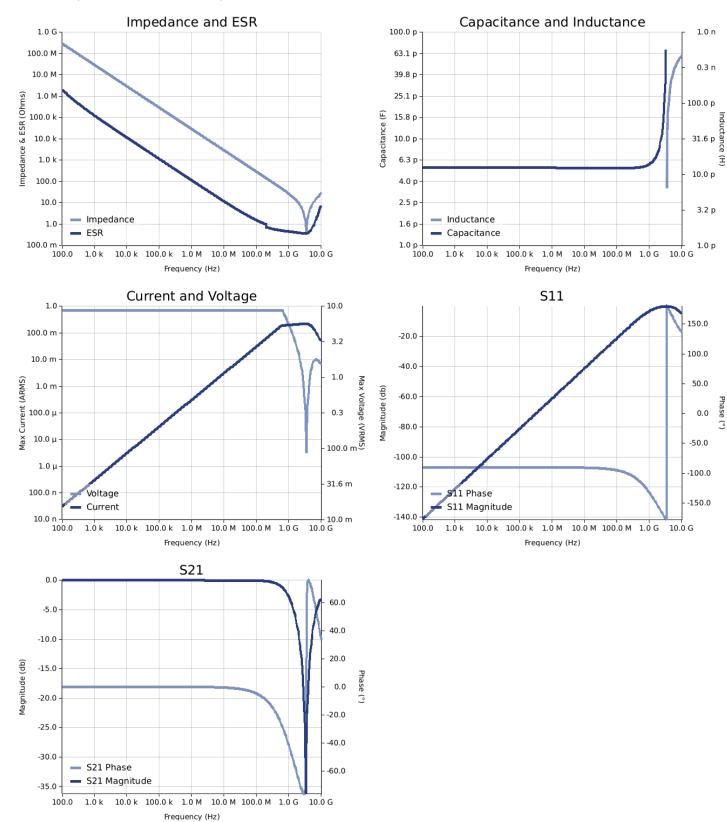
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CO805C519C3GACTU Aliases (C0805C519C3GAC7800) SMD Comm C0G, Ceramic, 5.1 pF, +/-0.25 pF, 25 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm

Simulations

For the complete simulation environment please visit K-SIM.





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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for hipple klipple current younge vs. requericy plots is the ESR at an bient temperature.
 The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
 The effects shown herein are based on measured data from a multiple part sample of the parts in question.
 Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages and the part of the parts of the part of the
- generated at any other harmonics.
 Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.